

M62419FP

Sound Controller for Car Stereo

REJ03F0207-0200

Rev.2.00

Sep 14, 2006

Features

- 4-channel source selector with gain setting buffer amplifier by the external resistances
- Volume (balance), loudness, tone (bass and treble) and fader control by serial data from MCU
- Input maximum voltage level; 2.8 Vrms

Application

Car audio, Mini stereo, etc

Recommended Operating Conditions

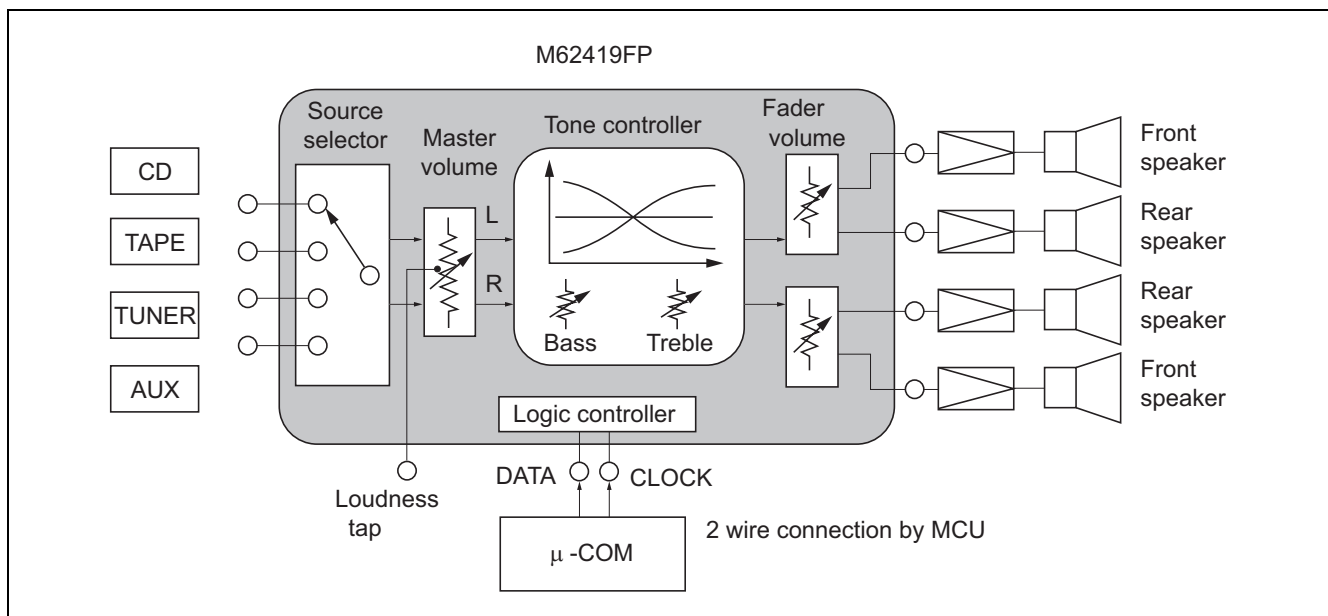
Supply voltage range: $V_{CC} = 6$ to 9 V

$V_{DD} = 4$ to 6 V

Rated supply voltage: $V_{CC} = 8$ V

$V_{DD} = 5$ V

System Block Diagram



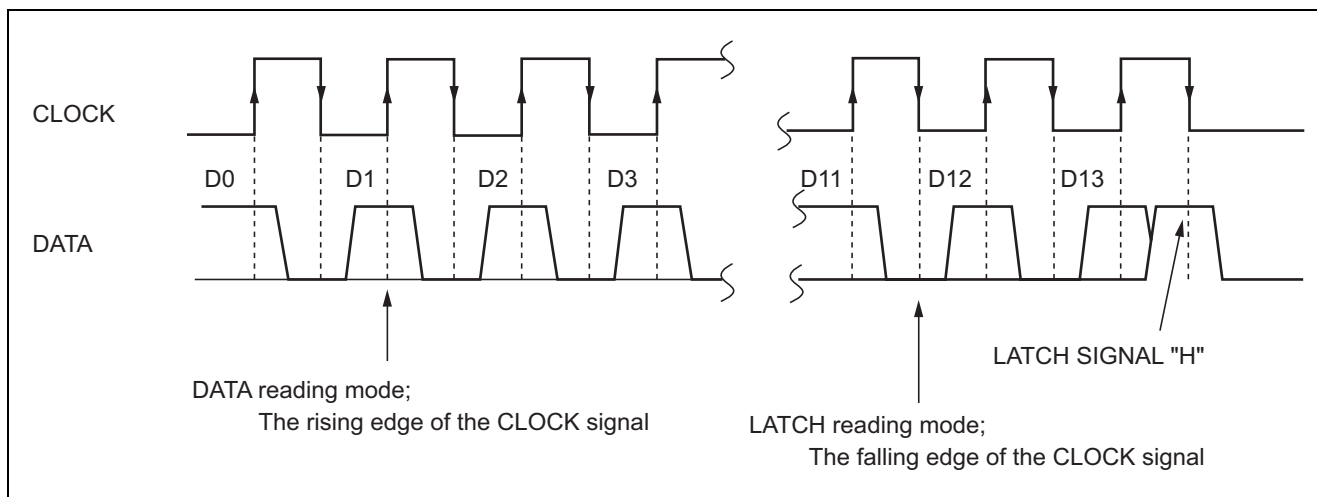
Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V_{CC}, V_{DD}	10, 7	V
Power dissipation	P_d	990	mW
Operating temperature	T_{opr}	-30 to +85	°C
Storage temperature	T_{stg}	-40 to +125	°C

Electrical Characteristics

Item	Symbol	Limits			Unit	Conditions
		Min	Typ	Max		
Circuit current	I_{CC}	—	22	40	mA	
Att maximum	$A_{TT} (VOL)$	—	-90	-80	dB	$A_{TT} (VOL) = -\infty$
Att error	$\Delta A_{TT} (VOL)$	-2.0	0	2.0	dB	$A_{TT} (VOL) = 0$
Maximum input voltage	V_{IM}	2.0	2.8	—	V _{rms}	THD = 1 %
Bass boost	G (Bass) B	9	12	15	dB	f = 100 Hz
Bass cut	G (Bass) C	-15	-12	-9	dB	f = 100 Hz
Treble boost	G (Tre) B	9	12	15	dB	f = 10 kHz
Treble cut	G (Tre) C	-15	-12	-9	dB	f = 10 kHz
Att maximum	$A_{TT} (FED)$	—	-80	-74	dB	$A_{TT} (FED) = -\infty$
Maximum output voltage	V_{OM}	1.8	2.2	—	V _{rms}	THD = 1 %
Output noise voltage	V_{NO1}	—	9	18	μV_{rms}	$A_{TT} (VOL) = 0, A_{TT} (FED) = 0$ R _g = 0, DIN-AUDIO
	V_{NO2}	—	5.5	11		$A_{TT} (VOL) = -\infty, A_{TT} (FED) = -\infty$ R _g = 0, DIN-AUDIO
Total harmonic distortion	THD	—	0.003	0.05	%	f = 1 kHz, V _o = 0.5 V _{rms} , Loud = OFF, $A_{TT} (VOL) = 0, A_{TT} (FED) = 0$
Channel separation	CS	—	-90	-80	dB	f = 1 kHz

Relationship between Data and Clock



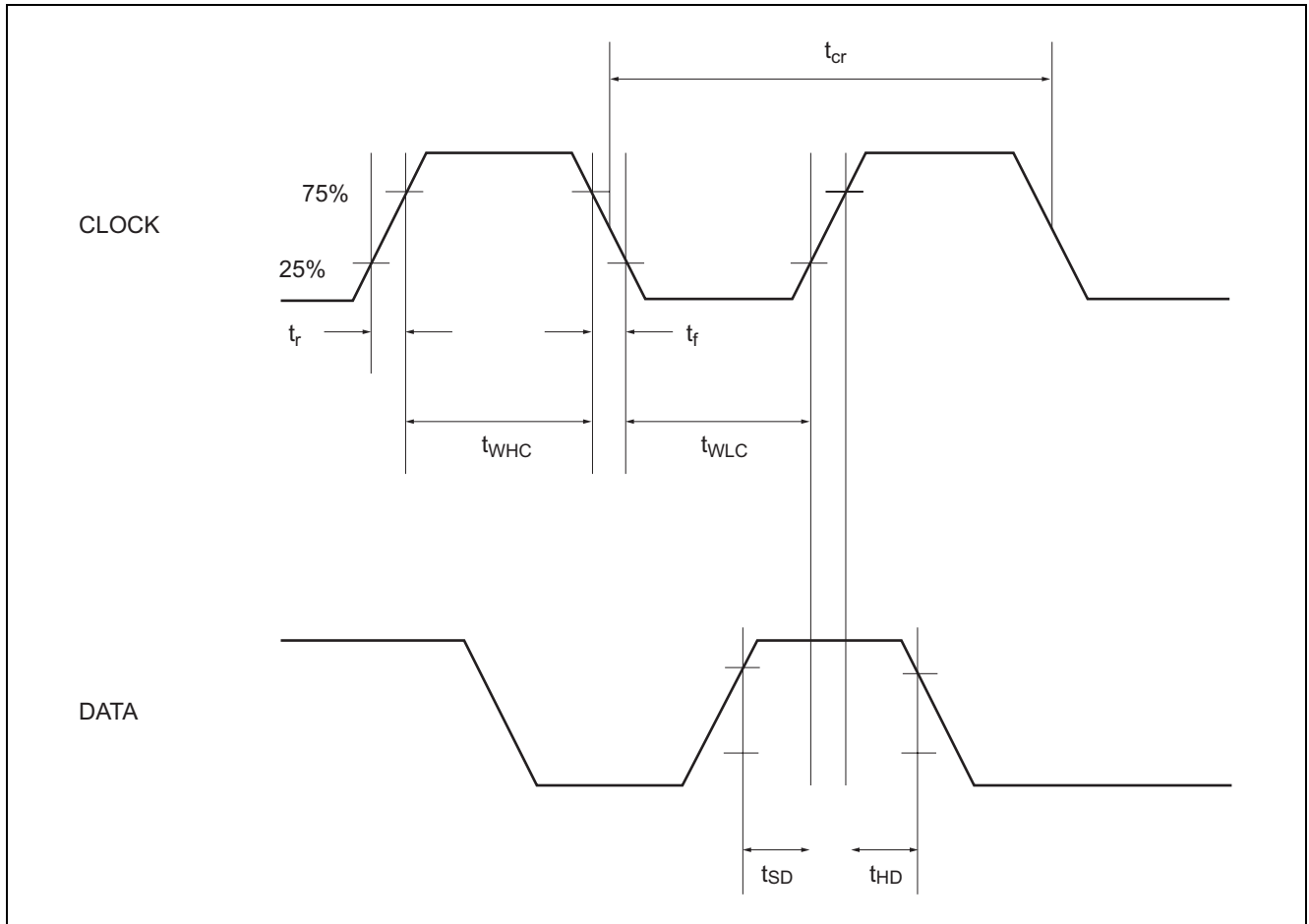
Digital Circuit DC Characteristics

Item	Symbol	Limits			Unit	Test Conditions	
		Min	Typ	Max			
"L" level input voltage	V_{IL}	0	~	$0.2 V_{DD}$	V	DATA, CLOCK pins	
"H" level input voltage	V_{IH}	$0.8 V_{DD}$	~	V_{DD}			
"L" level input current	I_{IL}	-10	—	10	μA	$V_i = 0$	DATA, CLOCK pins
"H" level input current	I_{IH}	—	—	10		$V_i = V_{DD}$	

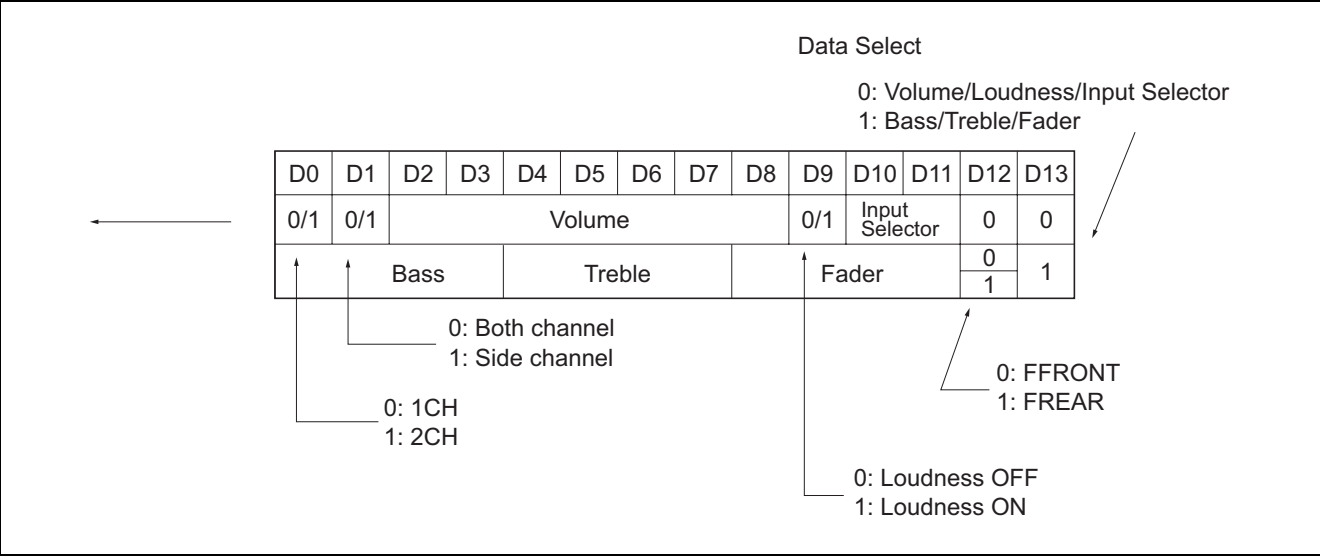
Digital Circuit AC Characteristics

Item	Symbol	Limits			Unit
		Min	Typ	Max	
CLOCK cycle time	t_{cr}	4	—	—	μS
CLOCK pulse width ("H" level)	t_{WHC}	1.6	—	—	
CLOCK pulse width ("L" level)	t_{WLC}	1.6	—	—	
CLOCK rise time	t_r	—	—	0.4	
CLOCK fall time	t_f	—	—	0.4	
DATA setup time	t_{SD}	0.8	—	—	
DATA hold time	t_{HD}	0.8	—	—	

Clock Data Timing



Data Format



Volume Code

ATT1	D2	D3	D4	D5	D6
0 dB	H	L	H	L	H
−4 dB	L	L	H	L	H
−8 dB	H	H	L	L	H
−12 dB	L	H	L	L	H
−16 dB	H	L	L	L	H
−20 dB	L	L	L	L	H
−24 dB	H	H	H	H	L
−28 dB	L	H	H	H	L
−32 dB	H	L	H	H	L
−36 dB	L	L	H	H	L
−40 dB	H	H	L	H	L
−44 dB	L	H	L	H	L
−48 dB	H	L	L	H	L
−52 dB	L	L	L	H	L
−56 dB	H	H	H	L	L
−60 dB	L	H	H	L	L
−64 dB	H	L	H	L	L
−68 dB	L	L	H	L	L
−72 dB	H	H	L	L	L
−76 dB	L	H	L	L	L
−80 dB	H	L	L	L	L
−∞	L	L	L	L	L

ATT2	D7	D8
0 dB	H	H
−1 dB	L	H
−2 dB	H	L
−3 dB	L	L

Tone Code

Bass	D0	D1	D2	D3
Treble	D4	D5	D6	D7
12 dB	H	H	H	H
10 dB	L	H	H	H
8 dB	H	L	H	H
6 dB	L	L	H	H
4 dB	H	H	L	H
2 dB	L	H	L	H
0 dB	H	L	L	H
-2 dB	L	L	L	H
-4 dB	H	H	H	L
-6 dB	L	H	H	L
-8 dB	H	L	H	L
-10 dB	L	L	H	L
-12 dB	H	H	L	L

Fader Code

Fader	D8	D9	D10	D11
0 dB	H	H	H	H
-1 dB	L	H	H	H
-2 dB	H	L	H	H
-3 dB	L	L	H	H
-4 dB	H	H	L	H
-6 dB	L	H	L	H
-8 dB	H	L	L	H
-10 dB	L	L	L	H
-12 dB	H	H	H	L
-14 dB	L	H	H	L
-16 dB	H	L	H	L
-20 dB	L	L	H	L
-30 dB	H	H	L	L
-45 dB	L	H	L	L
-60 dB	H	L	L	L
$-\infty$	L	L	L	L

Input Selector Code

Input Selector	D10	D11
A CH	H	H
B CH	L	H
C CH	H	L
D CH	L	L

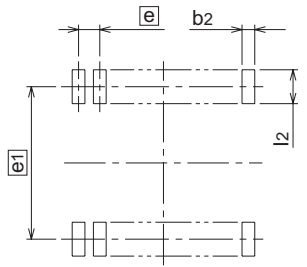
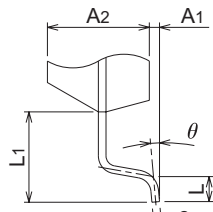
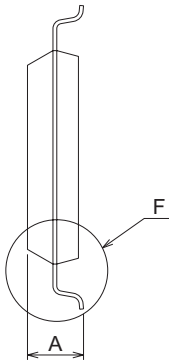
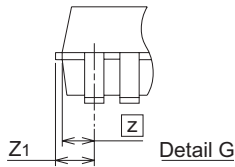
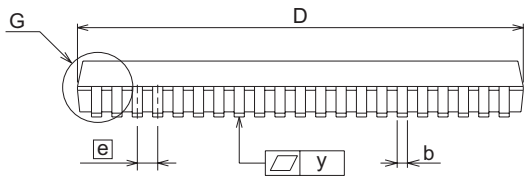
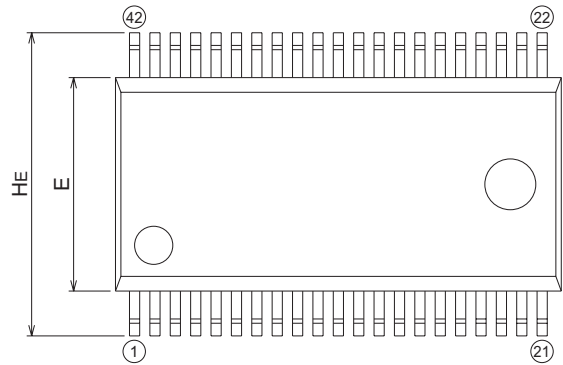
Package Dimensions

42P2R-A



Plastic 42pin 450mil SSOP

EIAJ Package Code	JEDEC Code	Weight(g)	Lead Material
SSOP42-P-450-0.80	—	0.63	Alloy 42/Cu Alloy



Recommended Mount Pad

Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	—	—	2.4
A1	0.05	—	—
A2	—	2.0	—
b	0.35	0.4	0.5
c	0.13	0.15	0.2
D	17.3	17.5	17.7
E	8.2	8.4	8.6
e	—	0.8	—
HE	11.63	11.93	12.23
L	0.3	0.5	0.7
L1	—	1.765	—
z	—	0.75	—
Z1	—	—	0.9
y	—	—	0.15
θ	0°	—	10°
b2	—	0.5	—
e1	—	11.43	—
l2	1.27	—	—

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Renesas Technology Europe Limited

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Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.

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Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: <603> 7955-9390, Fax: <603> 7955-9510